74LV164 8-bit serial-in/parallel-out shift register Rev. 03 — 4 February 2005

Product data sheet

1. General description

The 74LV164 is a low-voltage, Si-gate CMOS device and is pin and function compatible with the 74HC164 and 74HC164.

The 74LV164 is an 8-bit edge-triggered shift register with serial data entry and an output from each of the eight stages. Data is entered serially through one of two inputs (DSA or DSB) and either input can be used as an active HIGH enable for data entry through the other input. Both inputs must be connected together or an unused input must be tied HIGH.

Data shifts one place to the right on each LOW-to-HIGH transition of the clock input (CP) and enters into Q0, which is the logical AND-function of the two data inputs (DSA and DSB) that existed one set-up time prior to the rising clock edge.

A LOW on the master reset input (MR) overrides all other inputs and clears the register asynchronously, forcing all outputs LOW.

2. Features

- Wide operating voltage: 1.0 V to 5.5 V
- Optimized for low-voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce): < 0.8 V at V_{CC} = 3.3 V and T_{amb} = 25 °C
- Typical V_{OHV} (output V_{OH} undershoot): > 2 V at V_{CC} = 3.3 V and T_{amb} = 25 °C
- Gated serial data inputs
- Asynchronous master reset
- **ESD** protection:
 - HBM EIA/JESD22-A114-B exceeds 2000 V
 - MM EIA/JESD22-A115-A exceeds 200 V.
- Specified from -40 °C to +80 °C and from -40 °C to +125 °C.

3. Quick reference data

Table 1:Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{PHL} ,	propagation delay	$V_{CC} = 3.3 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$				
t _{PLH}	CP to Qn		-	12	-	ns
	MR to Qn		-	12	-	ns



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Table 1:	Quick	reference	data	continued

 $GND = 0 V; T_{amb} = 25 \circ C; t_f = t_f \le 2.5 \text{ ns.}$

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
f _{max}	maximum clock frequency	$V_{CC} = 3.3 \text{ V}; C_{L} = 15 \text{ pF}$		-	78	-	MHz
CI	input capacitance			-	3.5	-	pF
C_{PD}	power dissipation capacitance per gate	$V_{CC} = 3.3 V$	[1][2]	-	40	-	pF

- [1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).
 - $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:
 - f_i = input frequency in MHz;
 - $f_o = output frequency in MHz;$
 - C_L = output load capacitance in pF;
 - V_{CC} = supply voltage in V;
 - N = number of inputs switching;
 - $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.
- [2] The condition is $V_I = GND$ to V_{CC} .

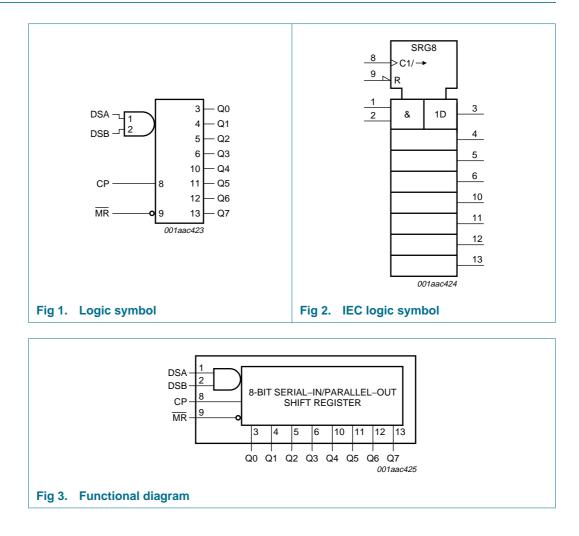
4. Ordering information

Table 2:Ordering information

Type number	Type number Package						
	Temperature range	rature range Name Description					
74LV164N	–40 °C to +125 °C	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1			
74LV164D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			
74LV164DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1			
74LV164PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LV164BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1			

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5. Functional diagram

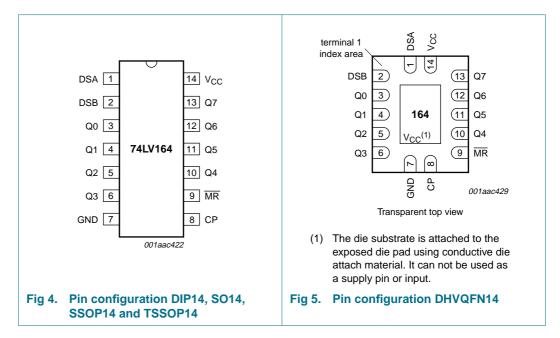


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6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3:	Pin des	Pin description				
Symbol	Pin	Description				
DSA	1	data input SA				
DSB	2	data input SB				
Q0	3	output 0				
Q1	4	output 1				
Q2	5	output 2				
Q3	6	output 3				
GND	7	ground (0 V)				
СР	8	clock input (edge triggered LOW-to-HIGH)				
MR	9	master reset input (active LOW)				
Q4	10	output 4				
Q5	11	output 5				
Q6	12	output 6				
Q7	13	output 7				
V _{CC}	14	supply voltage				

7. Functional description

7.1 Function table

Table 4: Function table [1]

Operating	Input					Output		
mode	MR	СР	DSA	DSB	Q0	Q1 to Q7		
Reset (clear)	L	Х	X	Х	L	L to L		
Shift	Н	\uparrow	I	I	L	q0 to q6		
	Н	\uparrow	I	h	L	q0 to q6		
	Н	\uparrow	h	I	L	q0 to q6		
	Н	\uparrow	h	h	Н	q0 to q6		

[1] H = HIGH voltage level;

L = LOW voltage level;

 \uparrow = LOW-to-HIGH clock transition;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition;

 ${\sf q}$ = lower case letter indicates the state of referenced input one set-up time prior to the LOW-to-HIGH CP transition.

8. Limiting values

Table 5:Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input diode current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V		-	±20	mA
I _{OK}	output diode current	$V_{\rm O}$ < –0.5 V or $~V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V		-	±50	mA
I _O	output source or sink current	$V_{O} = -0.5 \text{ V} \text{ to } (V_{CC} + 0.5 \text{ V})$	<u>[1]</u>	-	±25	mA
I _{CC} , I _{GND}	V _{CC} or GND current			-	±50	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$				
	DIP14 package		[2]	-	750	mW
	SO14, (T)SSOP14 and DHVQFN14 packages		[3]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] DIP14 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[3] SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

(T)SSOP14 package: P_{tot} derates linearly with 5.5 mW/K above 60 °C. DHVQFN14 package: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

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9. Recommended operating conditions

Table 6:	Recommended operating conditions							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _{CC}	supply voltage		[1]	1.0	3.3	5.5	V	
VI	input voltage			0	-	V_{CC}	V	
Vo	output voltage			0	-	V_{CC}	V	
T _{amb}	ambient temperature	in free air		-40	-	+125	°C	
t _r , t _f	input rise and fall times	V_{CC} = 1.0 V to 2.0 V		-	-	500	ns/V	
		V_{CC} = 2.0 V to 2.7 V		-	-	200	ns/V	
		V_{CC} = 2.7 V to 3.6 V		-	-	100	ns/V	
		V_{CC} = 3.6 V to 5.5 V		-	-	50	ns/V	

[1] The static characteristics are guaranteed from V_{CC} = 1.2 V to V_{CC} = 5.5 V, but LV devices are guaranteed to function down to V_{CC} = 1.0 V (with input levels GND or V_{CC}).

10. Static characteristics

Table 7: Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = –	40 °C to +85 °C <u>[1]</u>					
VIH	HIGH-level input voltage	$V_{CC} = 1.2 V$	0.9	-	-	V
		$V_{CC} = 2.0 V$	1.4	-	-	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	2.0	-	-	V
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	$0.7 imes V_{CO}$	c -	-	V
VIL	LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.3	V
		$V_{CC} = 2.0 V$	-	-	0.6	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	-	0.8	V
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	-	-	$0.3 imes V_{CC}$	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 1.2 \ V$	-	1.2	-	V
		$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 2.0 \ V$	1.8	2.0	-	V
		$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 2.7 \ \text{V}$	2.5	2.7	-	V
		$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 3.0 \ V$	2.8	3.0	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	2.82	-	V
		$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	4.3	4.5	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.60	4.20	-	V

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Table 7: Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = 100 \ \mu\text{A}; \ V_{CC} = 1.2 \ \text{V}$	-	0	-	V
		$I_{O} = 100 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	-	0	0.2	V
		$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 2.7 \ \text{V}$	-	0	0.2	V
		$I_{O} = 100 \ \mu\text{A}; \ V_{CC} = 3.0 \ \text{V}$	-	0	0.2	V
		$I_{O} = 6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.25	0.40	V
		$I_{O} = 100 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	-	0	0.2	V
		$I_0 = 12 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.35	0.55	V
LI	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	1.0	μΑ
l _{cc}	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	20.0	μΑ
∆l _{CC}	additional quiescent supply current per input	$V_{I} = V_{CC} - 0.6 \text{ V}; V_{CC} = 2.7 \text{ V}$ to 3.6 V	-	-	500	μΑ
Cı	input capacitance		-	3.5	-	pF
T _{amb} = -	40 °C to +125 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 1.2 V	0.9	-	-	V
		V _{CC} = 2.0 V	1.4	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	$0.7 \times V_{CC}$	-	-	V
VIL	LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.3	V
		V _{CC} = 2.0 V	-	-	0.6	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	V
		V_{CC} = 4.5 V to 5.5 V	-	-	$0.3 imes V_{CC}$	V
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = -100 \ \mu\text{A}; \ V_{CC} = 1.2 \ \text{V}$	-	-	-	V
		$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.8	-	-	V
		$I_0 = -100 \ \mu A; \ V_{CC} = 2.7 \ V$	2.5	-	-	V
		$I_{O} = -100 \ \mu A; \ V_{CC} = 3.0 \ V$	2.8	-	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.20	-	-	V
		$I_{O} = -100 \ \mu A; \ V_{CC} = 4.5 \ V$	4.3	-	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.50	-	-	V
√ _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 1.2 \ V$	-	-	-	V
		$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	-	-	0.2	V
		$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 2.7 \ V$	-	-	0.2	V
		$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 3.0 \ V$	-	-	0.2	V
		$I_0 = 6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V
		$I_{O} = 100 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	-	0.2	V
		$I_0 = 12 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.65	V

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Table 7: Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{LI}	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	1.0	μΑ
I _{CC}	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	160	μΑ
ΔI_{CC}	additional quiescent supply current per input	$V_{I} = V_{CC} - 0.6 \text{ V}; V_{CC} = 2.7 \text{ V}$ to 3.6 V	-	-	850	μA

[1] All typical values are measured at T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8: Dynamic characteristics

GND = 0 V; $t_r = t_f \le 2.5 \text{ ns}$; $C_L = 50 \text{ pF}$; $R_L = 1 \text{ k}\Omega$; for test circuit see Figure 9.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	40 °C to +85 °C [1]					
t _{PHL} , t _{PLH}	propagation delay CP to Qn	see <u>Figure 6</u>				
		V _{CC} = 1.2 V	-	75	-	ns
		$V_{CC} = 2.0 V$	-	26	39	ns
		$V_{CC} = 2.7 V$	-	19	29	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	14	23	ns
		V_{CC} = 4.5 V to 5.5 V	-	12	19	ns
		$V_{CC} = 3.3 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	12	-	ns
t _{PHL}	propagation delay MR to Qn	see Figure 7				
		V _{CC} = 1.2 V	-	75	-	ns
		$V_{CC} = 2.0 V$	-	26	39	ns
		$V_{CC} = 2.7 V$	-	19	29	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	14	23	ns
		V_{CC} = 4.5 V to 5.5 V	-	12	19	ns
		$V_{CC} = 3.3 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	12	-	ns
t _W	pulse width CP	see <u>Figure 6</u>				
		$V_{CC} = 2.0 V$	34	9	-	ns
		$V_{CC} = 2.7 V$	25	6	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	20	5	-	ns
		V_{CC} = 4.5 V to 5.5 V	13	4	-	ns
t _W	pulse width MR	see Figure 7				
		$V_{CC} = 2.0 V$	34	10	-	ns
		$V_{CC} = 2.7 V$	25	8	-	ns
		V_{CC} = 3.0 V to 3.6 V	20	6	-	ns
		V_{CC} = 4.5 V to 5.5 V	13	5	-	ns

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Symbol	Parameter	Conditions	N	Min	Тур	Max	Unit
t _{rem}	removal time MR to CP	see Figure 7					
		$V_{CC} = 1.2 V$	-		30	-	ns
		$V_{CC} = 2.0 V$	1	19	10	-	ns
		$V_{CC} = 2.7 V$	1	14	8	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1	11	6	-	ns
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	8	3	5	-	ns
t _{su}	set-up time Dn to CP	see Figure 8					
		V _{CC} = 1.2 V	-		15	-	ns
		$V_{CC} = 2.0 V$	2	22	5	-	ns
		$V_{CC} = 2.7 V$	1	16	4	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1	13	3	-	ns
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	ç	Э	2	-	ns
t _h	hold time Dn to CP	see Figure 8					
		V _{CC} = 1.2 V	-	•	-10	-	ns
		$V_{CC} = 2.0 V$	5	5	-3	-	ns
		$V_{CC} = 2.7 V$	5	5	-2	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	5	5	-2	-	ns
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	5	5	-1	-	ns
f _{max}	maximum clock frequency	see Figure 6					
		$V_{CC} = 2.0 V$	1	14	40	-	MHz
		$V_{CC} = 2.7 V$	1	19	58	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2	24	70	-	MHz
		V_{CC} = 4.5 V to 5.5 V	3	36	100	-	MHz
		$V_{CC} = 3.3 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-		78	-	MHz
C _{PD}	power dissipation capacitance per gate	V _{CC} = 3.3 V	<u>[2] [3]</u> _		40	-	pF
T _{amb} = –	40 °C to +125 °C						
t _{PHL} ,	propagation delay CP to Qn	see Figure 6					
t _{PLH}		V _{CC} = 1.2 V	-	•	-	-	ns
		$V_{CC} = 2.0 V$	-	•	-	49	ns
		$V_{CC} = 2.7 V$	-		-	36	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-		-	29	ns
		V_{CC} = 4.5 V to 5.5 V	-		-	24	ns
^t PHL	propagation delay MR to Qn	see Figure 7					
		$V_{CC} = 1.2 V$	-		-	-	ns
		$V_{CC} = 2.0 V$	-		-	49	ns
		$V_{CC} = 2.7 V$	-		-	36	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-		-	29	ns
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	-		-	24	ns

Dynamic characteristics ... continued Table 8:

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _W	pulse width CP	see <u>Figure 6</u>				
		$V_{CC} = 2.0 V$	41	-	-	ns
		$V_{CC} = 2.7 V$	30	-	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	24	-	-	ns
		$V_{CC} = 4.5 \text{ V}$ to 5.5 V	16	-	-	ns
t _W	pulse width MR	see Figure 7				
		$V_{CC} = 2.0 V$	41	-	-	ns
		$V_{CC} = 2.7 V$	30	-	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	24	-	-	ns
		V_{CC} = 4.5 V to 5.5 V	16	-	-	ns
rem	removal time $\overline{\text{MR}}$ to CP	see Figure 7				
		V _{CC} = 1.2 V	-	-	-	ns
		$V_{CC} = 2.0 V$	24	-	-	ns
		$V_{CC} = 2.7 V$	18	-	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	14	-	-	ns
		V_{CC} = 4.5 V to 5.5 V	10	-	-	ns
t _{su}	set-up time Dn to CP	see Figure 8				
		V _{CC} = 1.2 V	-	-	-	ns
		$V_{CC} = 2.0 V$	26	-	-	ns
		$V_{CC} = 2.7 V$	19	-	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	15	-	-	ns
		V_{CC} = 4.5 V to 5.5 V	10	-	-	ns
h	hold time Dn to CP	see Figure 8				
		V _{CC} = 1.2 V	-	-	-	ns
		$V_{CC} = 2.0 V$	5	-	-	ns
		$V_{CC} = 2.7 V$	5	-	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	5	-	-	ns
		V_{CC} = 4.5 V to 5.5 V	5	-	-	ns
max	maximum clock frequency	see Figure 6				
		$V_{CC} = 2.0 V$	12	-	-	MHz
		$V_{CC} = 2.7 V$	16	-	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	20	-	-	MHz
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	30	-	-	MHz

Table 8: Dynamic characteristics ... continued GND = 0.1/t = t < 2.5 ns; C = 50 ns; R = 1 kO; ft

at air -

[1] Typical values are measured at nominal V_{CC} and T_{amb} = 25 °C.

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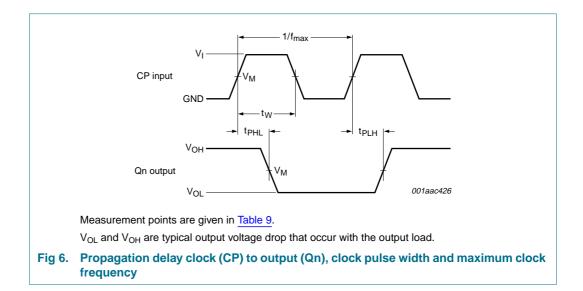
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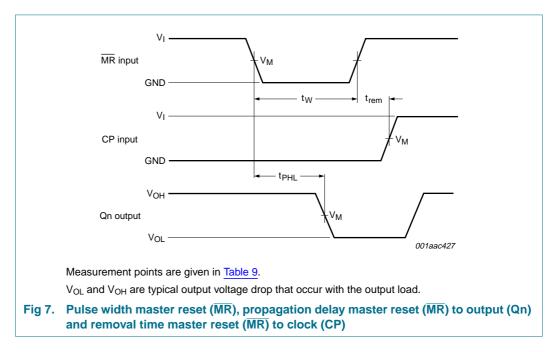
 $\begin{array}{ll} \mbox{[2]} & C_{PD} \mbox{ is used to determine the dynamic power dissipation (P_D in μW). } \\ & P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \mbox{ where:} \\ & f_i = \mbox{ input frequency in MHz;} \\ & f_o = \mbox{ output frequency in MHz;} \\ & C_L = \mbox{ output load capacitance in pF;} \\ & V_{CC} = \mbox{ supply voltage in V;} \end{array}$

$$\begin{split} N &= number \mbox{ of inputs switching;} \\ \Sigma(C_L \times V_{CC}{}^2 \times f_o) &= sum \mbox{ of the outputs.} \end{split}$$

[3] The condition is $V_I = GND$ to V_{CC} .

12. Waveforms





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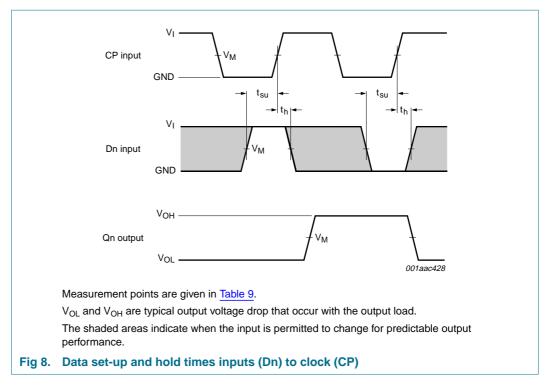


Table 9: Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _M
1.2 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$
2.0 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$

8-bit serial-in/parallel-out shift register

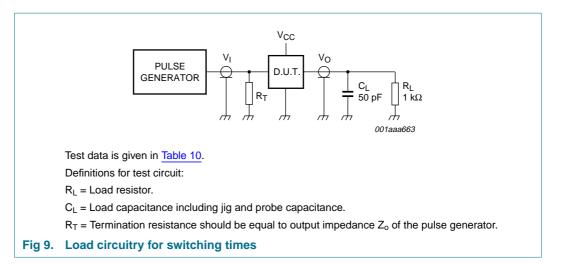


Table 10: Test data

Supply voltage	Input		Load	Load	
V _{CC}	VI	t _r , t _f	CL	RL	
1.2 V	V _{CC}	≤ 2.5 ns	50 pF	1 kΩ	t _{PHL} , t _{PLH}
2.0 V	V _{CC}	≤ 2.5 ns	50 pF	1 kΩ	t _{PHL} , t _{PLH}
2.7 V	2.7 V	\leq 2.5 ns	50 pF	1 kΩ	t _{PHL} , t _{PLH}
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF, 15 pF	1 kΩ	t _{PHL} , t _{PLH}
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	1 kΩ	t _{PHL} , t _{PLH}

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8-bit serial-in/parallel-out shift register

13. Package outline

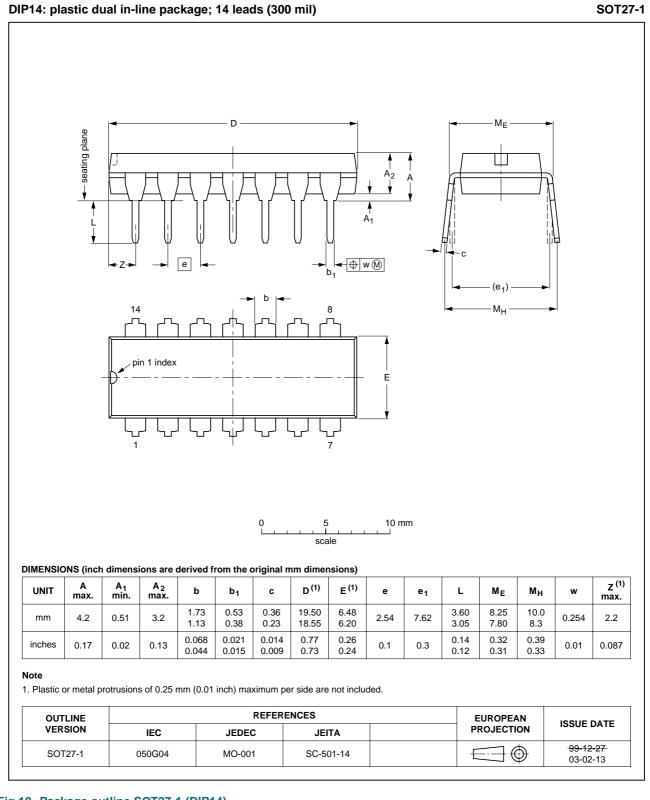


Fig 10. Package outline SOT27-1 (DIP14)

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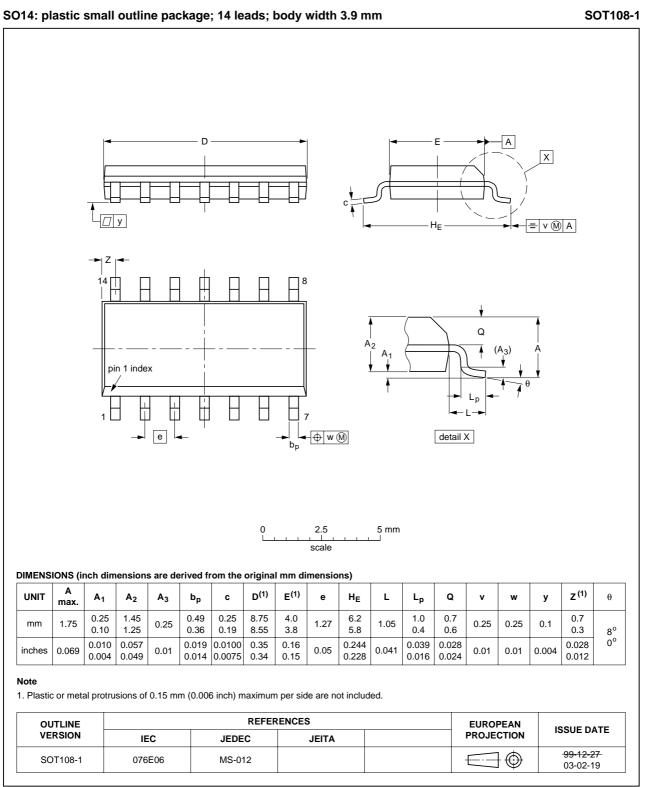


Fig 11. Package outline SOT108-1 (SO14)

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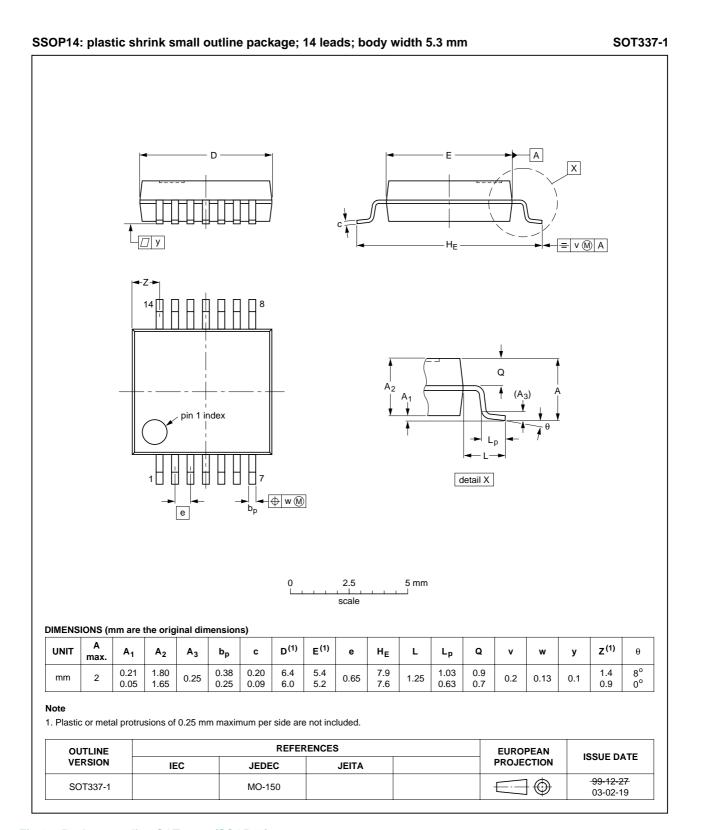


Fig 12. Package outline SOT337-1 (SSOP14)

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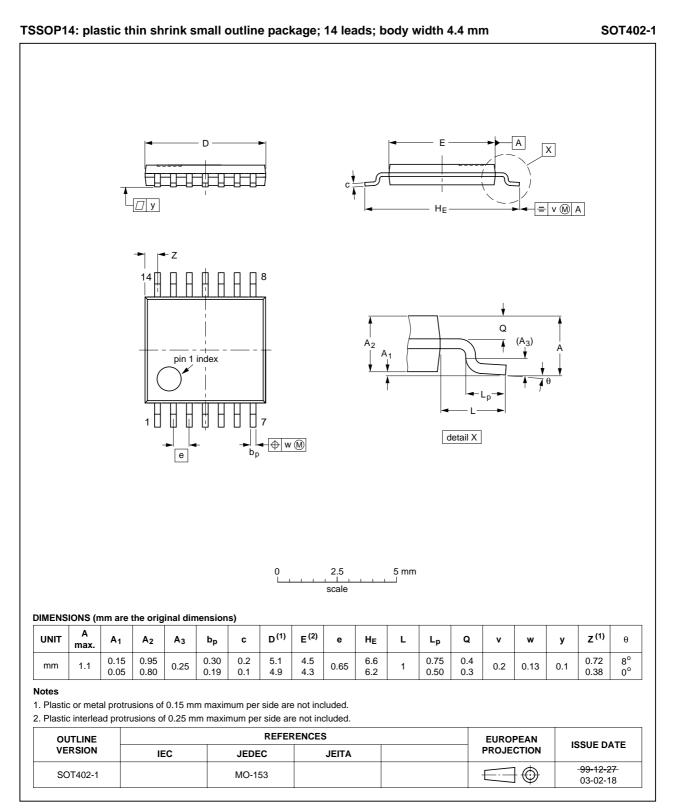
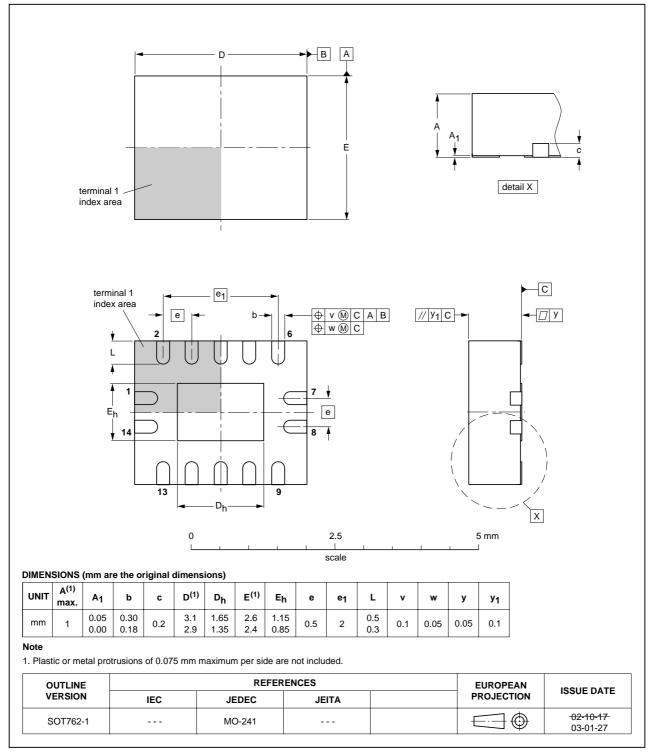


Fig 13. Package outline SOT402-1 (TSSOP14)

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Product data sheet

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 14. Package outline SOT762-1 (DHVQFN14)

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Product data sheet

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14. Revision history

Table 11: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
74LV164_3	20050204	Product data sheet	-	9397 750 14501	74LV164_2
Modifications:	information	t of this data sheet has be n standard of Philips Sem be number 74LV164BQ ([niconductors		rent presentation and
74LV164_2	19980507	Product specification	-	9397 750 04431	74LV164_1
74LV164_1	19970328	Product specification		-	-

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15. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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